

PROTECTION PRODUCTS - Z-Pak™

Description

RailClamp® TVS arrays are ultra low capacitance ESD protection devices designed to protect high speed data interfaces. They are designed to replace 0201 size multilayer varistors (MLVs) in portable applications such as cell phones, notebook computers, and other portable electronics. This device offers desirable characteristics for board level protection including fast response time, low operating and clamping voltage, and no device degradation.

The RClamp®0531Z has a typical capacitance of only 0.30pF. This allows it to be used on circuits operating in excess of 5GHz without signal attenuation.

The RClamp0531Z is in a 2-pin SLP0603P2X3B package. It measures 0.6 x 0.3 mm with a nominal height of only 0.25mm. The leads are finished with lead-free NiAu. Each device will protect one line operating at 5 volts. It gives the designer the flexibility to protect single lines in applications where arrays are not practical. The combination of small size and high ESD surge capability makes them ideal for use in portable applications such as cellular phones, digital cameras, and RF modules.

Features

- ◆ High ESD withstand Voltage: +/-**12kV** (Contact) and +/- **15kV** (Air) per **IEC 61000-4-2**
- ◆ Able to withstand over 1000 ESD strikes per IEC 61000-4-2 Level 4
- ◆ Ultra-small **0201 package**
- ◆ Protects one high-speed data line
- ◆ Low reverse current: <5nA typical (VR=5V)
- ◆ Working voltage: +/- 5V
- ◆ Low capacitance: 0.30pF typical
- ◆ Dynamic resistance: 0.67 Ohm (Typ)
- ◆ Solid-state silicon-avalanche technology

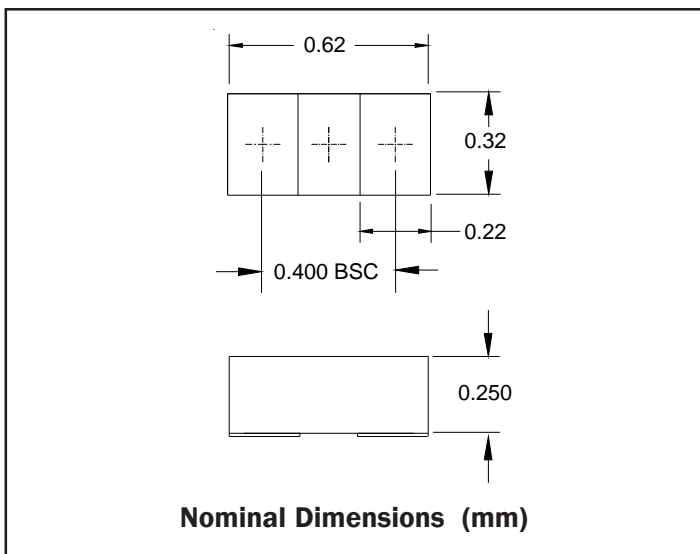
Mechanical Characteristics

- ◆ SLP0603P2X3B package
- ◆ Pb-Free, Halogen Free, RoHS/WEEE Compliant
- ◆ Nominal Dimensions: 0.6 x 0.3 x 0.25 mm
- ◆ Lead Finish: NiAu
- ◆ Marking : Marking code + dot matrix date code
- ◆ Packaging : Tape and Reel

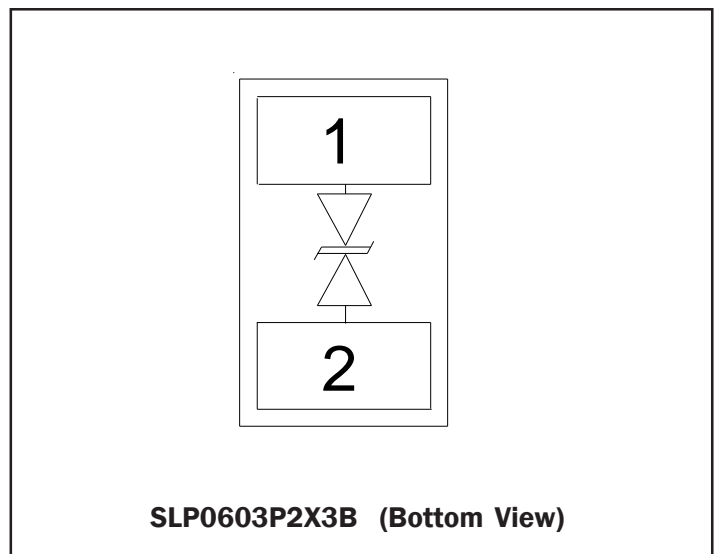
Applications

- ◆ RF Antenna and Modules
- ◆ FM Antenna
- ◆ USB 2.0
- ◆ MHL
- ◆ GPS

Dimensions



Circuit Diagram



PROTECTION PRODUCTS
Absolute Maximum Rating

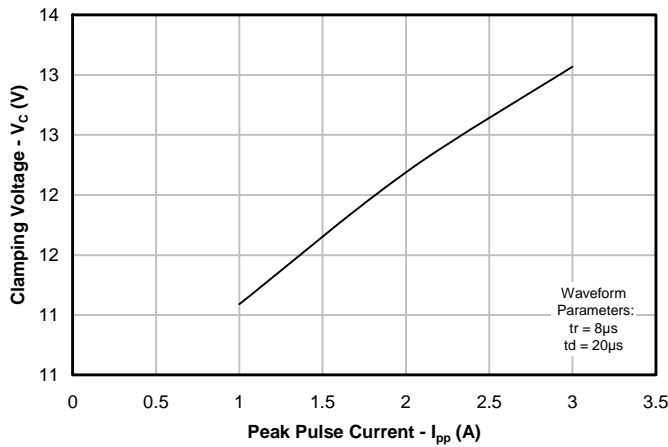
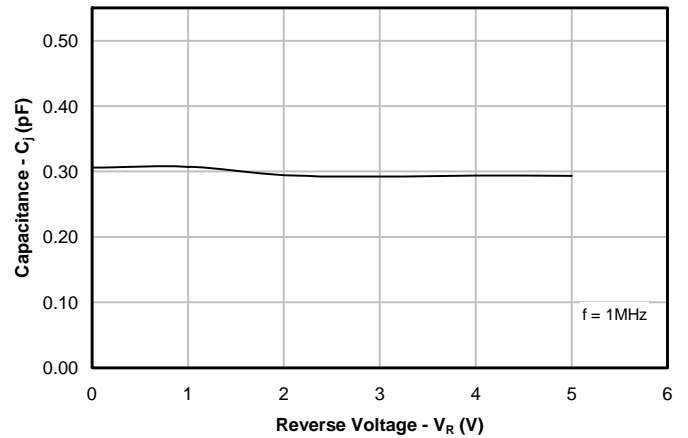
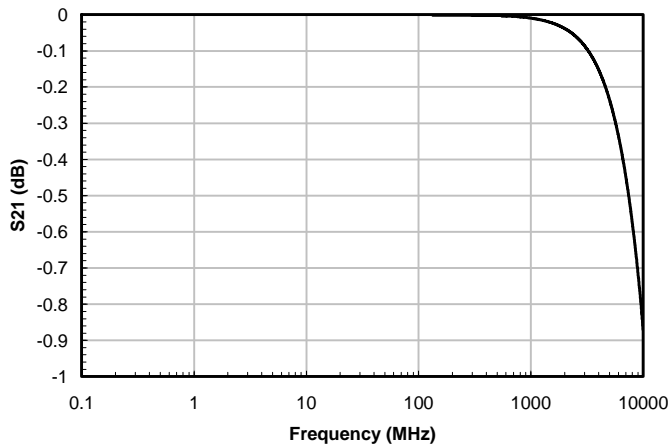
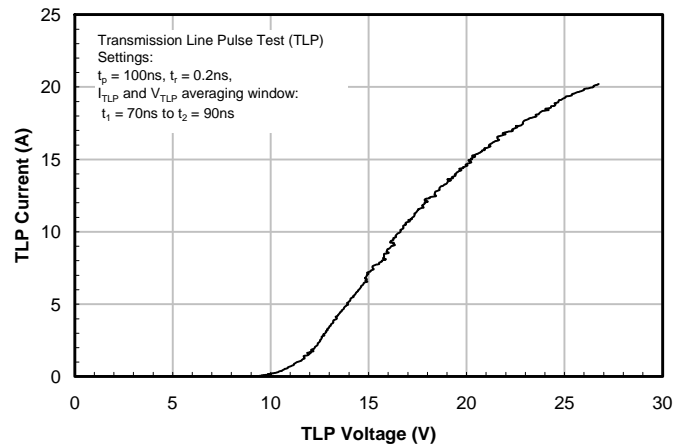
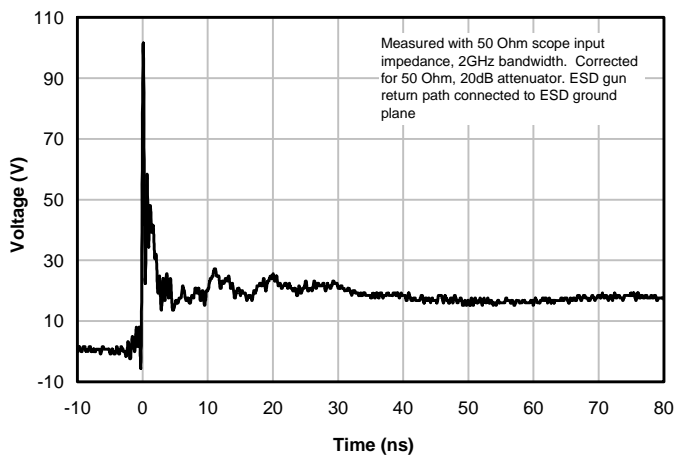
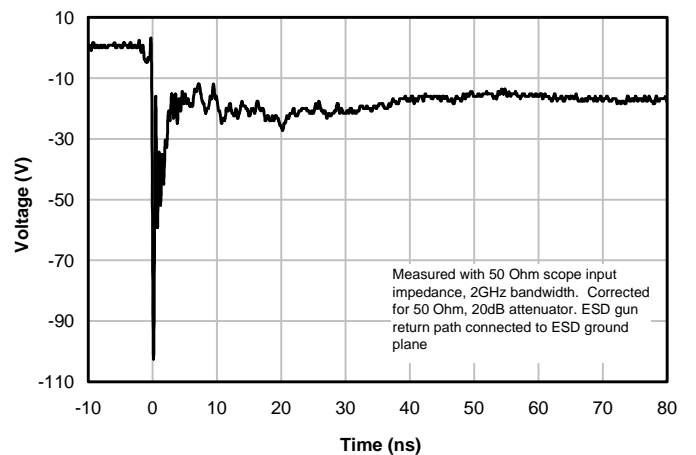
Rating	Symbol	Value	Units
Peak Pulse Power (tp = 8/20μs)	Ppk	60	Watts
Peak Pulse Current (tp = 8/20μs)	IPP	3	A
ESD per IEC 61000-4-2 (Air) ¹ ESD per IEC 61000-4-2 (Contact) ¹	V _{ESD}	+/- 15 +/- 12	kV
Operating Temperature	T _J	-55 to +125	°C
Storage Temperature	T _{STG}	-55 to +150	°C

Electrical Characteristics (T=25°C)

Parameter	Symbol	Conditions	Minimum	Typical	Maximum	Units
Reverse Stand-Off Voltage	V _{RWM}	Pin 1 to 2 or 2 to 1			5	V
Reverse Breakdown Voltage	V _{BR}	I _t = 1mA Pin 1 to 2 or 2 to 1	7	9	11	V
Reverse Leakage Current	I _R	V _{RWM} = 5V, T=25°C Pin 1 to 2 or 2 to 1		5	20	nA
Clamping Voltage	V _C	I _{PP} = 1A, tp = 8/20μs Pin 1 to 2 or 2 to 1			15	V
Clamping Voltage	V _C	I _{PP} = 3A, tp = 8/20μs Pin 1 to 2 or 2 to 1			20	V
ESD Clamping Voltage ²	V _C	IPP = 4A, t _{lp} = 0.2/100ns		13		V
ESD Clamping Voltage ²	V _C	IPP = 16A, t _{lp} = 0.2/100ns		21		V
Dynamic Resistance ^{2, 3}	R _D	tp = 100ns		0.67		Ohms
Junction Capacitance	C _J	V _R = 0V to 5V, f = 1MHz		0.30	0.40	pF
Junction Capacitance ⁴	C _J	V _R = 0V to 5V, f = 1GHz			0.40	pF
Change in Capacitance Over V _R ⁴	ΔC _{JVR}	V _R = 0V to 5V, f = 1MHz			0.040	pF

Notes

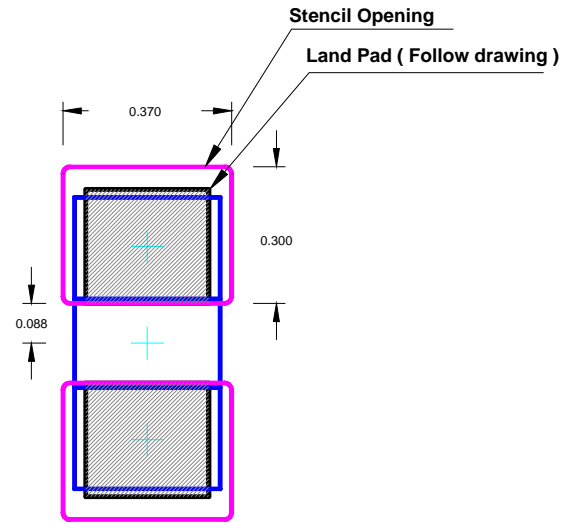
- 1)ESD gun return path connected to ESD ground reference plane.
- 2)Transmission Line Pulse Test (TLP) Settings: t_p = 100ns, t_r = 0.2ns, I_{TLP} and V_{TLP} averaging window: t₁ = 70ns to t₂ = 90ns.
- 3) Dynamic resistance calculated from I_{TLP} = 4A to I_{TLP} = 16A
- 4)Guaranteed by design. Not production tested

PROTECTION PRODUCTS
Typical Characteristics
Clamping Voltage vs. Peak Pulse Current

Junction Capacitance vs. Reverse Voltage

Typical Insertion Loss (S21)

TLP Characteristic

ESD Clamping (+8kV Contact per IEC 61000-4-2)

ESD Clamping (-8kV Contact per IEC 61000-4-2)


PROTECTION PRODUCTS
Applications Information
Assembly Guidelines

The small size of this device means that some care must be taken during the mounting process to insure reliable solder joint. The table below provides Semtech's recommended assembly guidelines for mounting this device. The figure at the right details Semtech's recommended aperture based on the below recommendations. Note that these are only recommendations and should serve only as a starting point for design since there are many factors that affect the assembly process. The exact manufacturing parameters will require some experimentation to get the desired solder application.

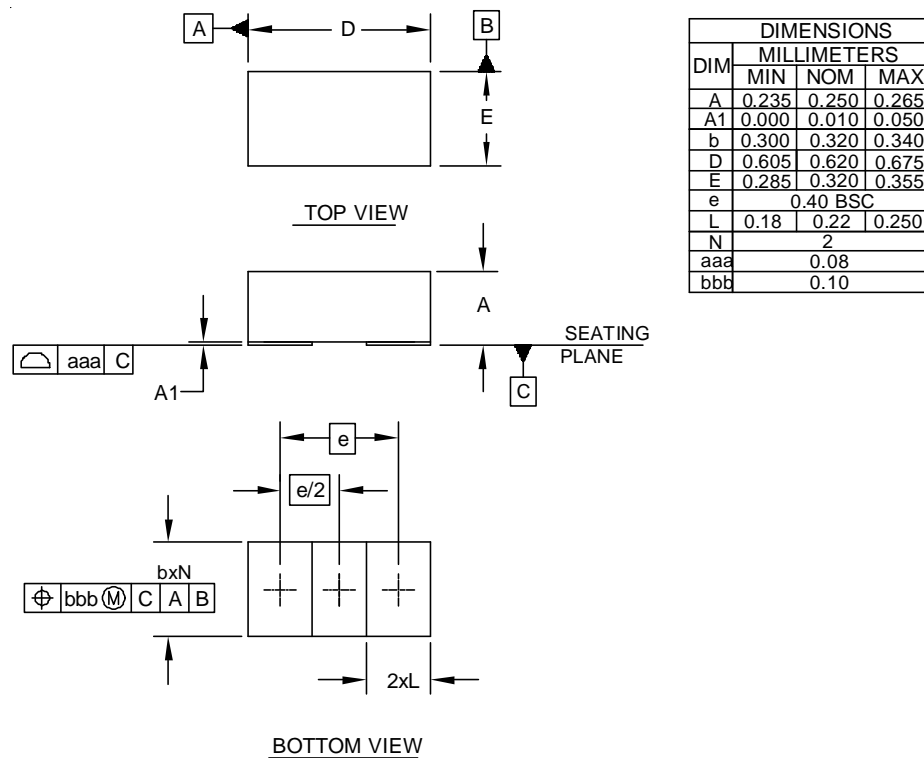
Assembly Parameter	Recommendation
Solder Stencil Design	Laser cut, Electro-polished
Aperture shape	Rectangular with rounded corners
Solder Stencil Thickness	0.100 mm (0.004")
Solder Paste Type	Type 4 size sphere or smaller
Solder Reflow Profile	Per JEDEC J-STD-020
PCB Solder Pad Design	Non-Solder mask defined
PCB Pad Finish	OSP OR NiAu



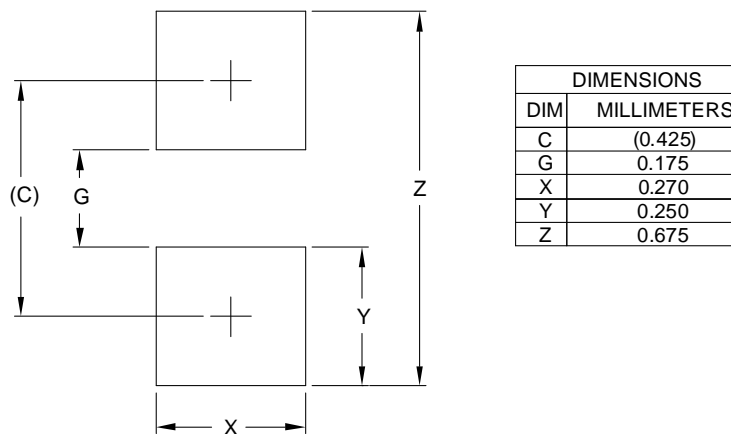
All Dimensions are in mm.

 Land Pad.
  Stencil opening
  Component

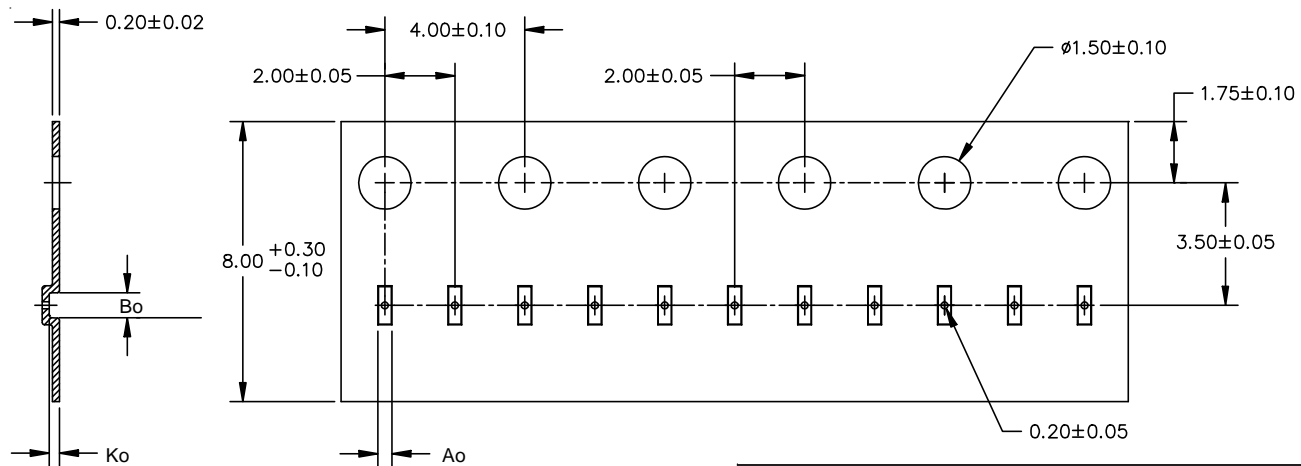
Recommended Mounting Pattern

PROTECTION PRODUCTS
Outline Drawing - SLP0603P2X3B


NOTES:
1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES).

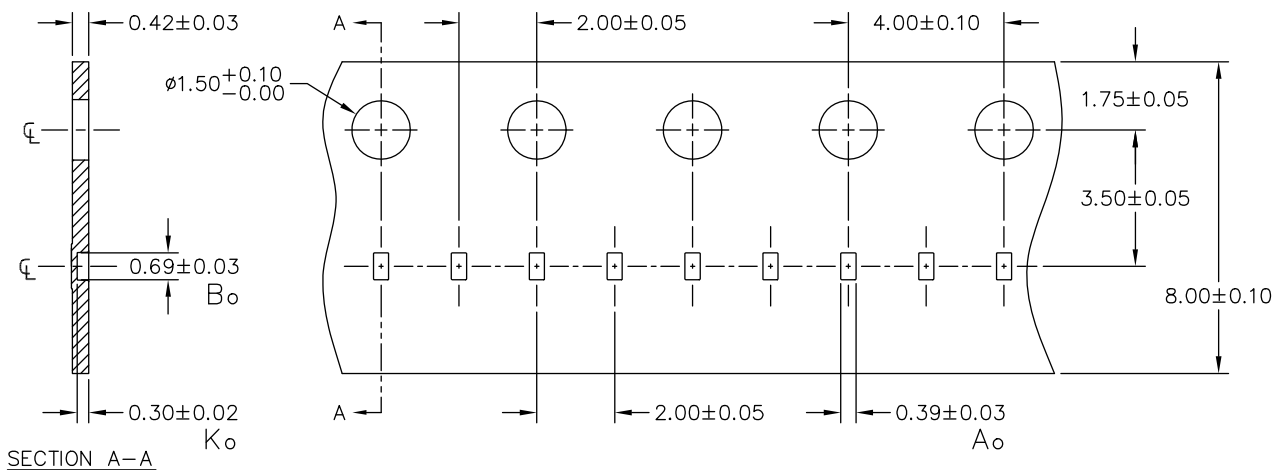
Land Pattern - SLP0603P2X3B


NOTES:
1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES).
2. THIS LAND PATTERN IS FOR REFERENCE PURPOSES ONLY.
CONSULT YOUR MANUFACTURING GROUP TO ENSURE YOUR COMPANY'S MANUFACTURING GUIDELINES ARE MET.

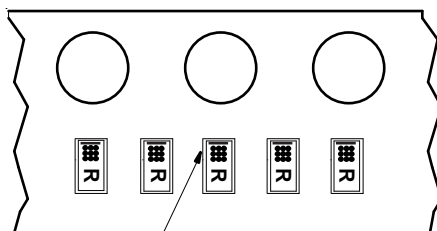
PROTECTION PRODUCTS
Carrier Tape Specification
Plastic Tape


A0	B0	K0
0.40 +/-0.05 mm	0.71 +/-0.05 mm	0.29 +/-0.05 mm

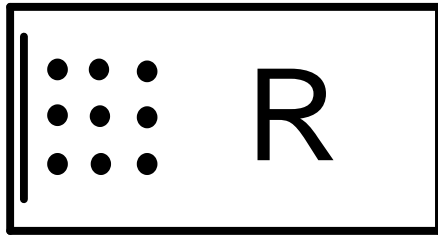
Note: All dimensions in mm unless otherwise specified

Paper Tape


NOTES: ALL DIMENSIONS IN MILLIMETERS UNLESS OTHERWISE SPECIFIED.

Device Orientation in Tape


PIN 1 Location
(Towards Sprocket Holes)

PROTECTION PRODUCTS
Marking Codes


Notes:

1)Dots represent date code matrix and Pin 1 location

Ordering Information

Ordering Number	Qty per Reel	Carrier Tape	Reel Size	Comments
RClamp0531Z.TNT	10,000	Plastic	7 Inch	Not recommended for new designs
RClamp0531Z.TFT	15,000	Paper	7 Inch	

RailClamp and RClamp are trademarks of Semtech Corporation.

Contact Information

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